

New Product

Vishay Siliconix

N-Channel 200-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)	Q _g (Typ)	
200	0.053 at V _{GS} = 15 V	36	57	
	0.054 at V _{GS} = 10 V	36	57	

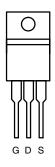
FEATURES

- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested

APPLICATIONSPower SupplyLighting Systems

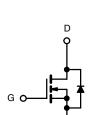


TO-220AB



Top View

Ordering Information: SUP36N20-54P-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless ot	herwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	200		
Gate-Source Voltage		V _{GS}	± 25	V	
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	I-	36	^	
Continuous Diam Current (1) = 173 C)	T _C = 100 °C	I _D	22.6		
Pulsed Drain Current		I _{DM}	80	Α	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20]	
Single Pulse Avalanche Energy ^a	L = 0.111111	E _{AS}	20	mJ	
	T _C = 25 °C	В	166 ^b	W	
Maximum Power Dissipation ^a	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C^c$	$ P_D$	3.12		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	- °C/W	
Junction-to-Case (Drain)	R _{thJC}	0.75		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).

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SPECIFICATIONS $T_J = 25$	°C, unless	otherwise noted				
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	
Gate-Body Leakage	1	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Gate-Dody Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 300	
	I _{DSS}	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
Zero Gate Voltage Drain Current		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$			25	
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α
		V _{GS} = 10 V, I _D = 20 A		0.044	0.054	Ω
Due in Course On Otata Decistance	r · ·	V _{GS} = 15 V, I _D = 20 A		0.0435	0.053	
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 100 ^{\circ}\text{C}$			0.098	
		V _{GS} = 10 V, I _D = 20 A, T _J = 150 °C			0.130	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25			S
Dynamic ^b	•			•		
Input Capacitance	C _{iss}			3100		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		300		
Reverse Transfer Capacitance	C _{rss}			135		
Tatal Cata Chausac		$V_{DS} = 100 \text{ V}, V_{GS} = 15 \text{ V}, I_D = 50 \text{ A}$		85	127	
Total Gate Charge ^c	Q_g			57	85	nC
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		14		
Gate-Drain Charge ^c	Q_{gd}			20		
Gate Resistance	R_{g}	f = 1 MHz		1.2	1.8	Ω
Turn-On Delay Time ^c	t _{d(on)}			16	25	ns ns
Rise Time ^c	t _r	$V_{DD} = 100 \text{ V}, R_{L} = 2 \Omega$		170	260	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		27	42	
Fall Time ^c	t _f			9	18	
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b		•		•
Continuous Current	I _S				36	А
Pulsed Current	I _{SM}				80	
Forward Voltage ^a	V_{SD}	I _F = 20 A, V _{GS} = 0 V		0.86	1.5	V
Reverse Recovery Time	t _{rr}	I _F = 40 A, di/dt = 100 A/μs		116	175	ns
Peak Reverse Recovery Current	I _{RM(REC)}			9	14	Α
Reverse Recovery Charge	Q _{rr}			0.53	0.8	μC
Reverse Recovery Fall Time	t _a			84		nS
Reverse Recovery Rise Time	t _b			32		

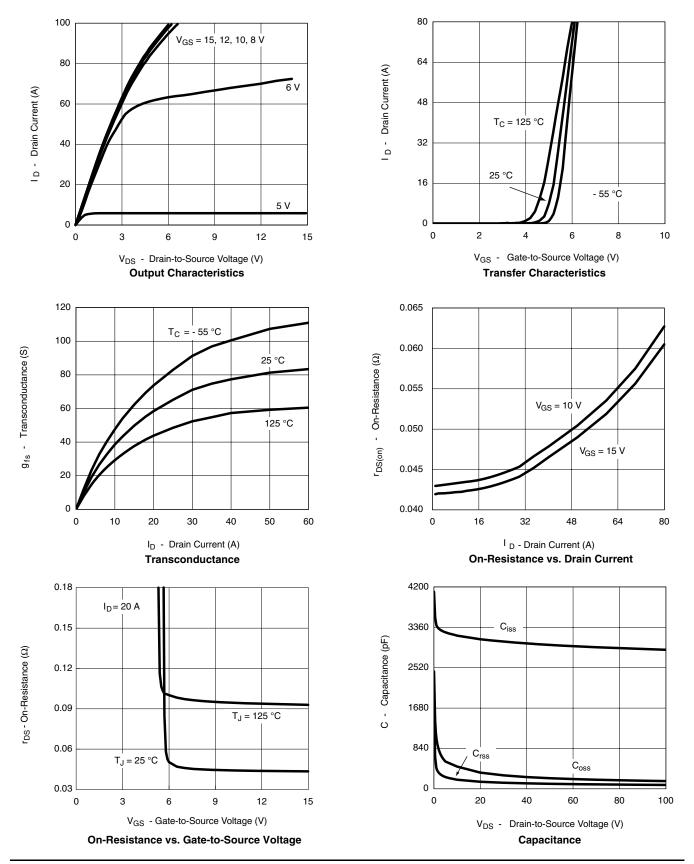
Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

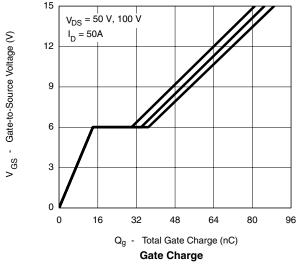


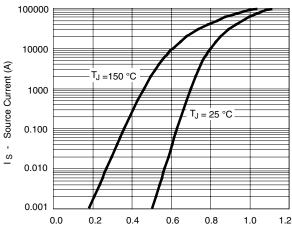
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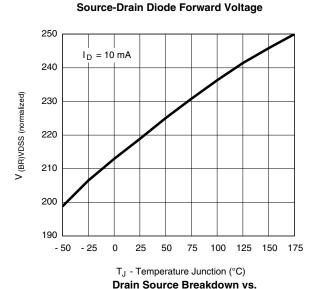
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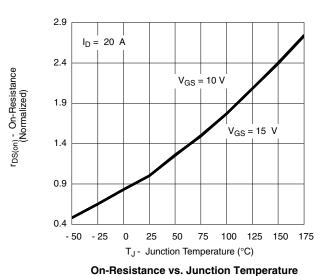


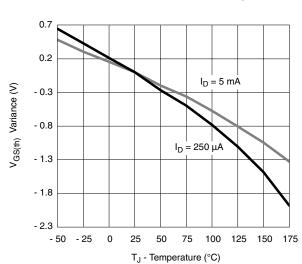


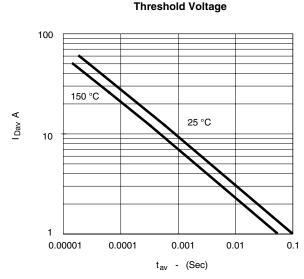
V_{SD} - Source-to-Drain Voltage (V)



Junction Temperature



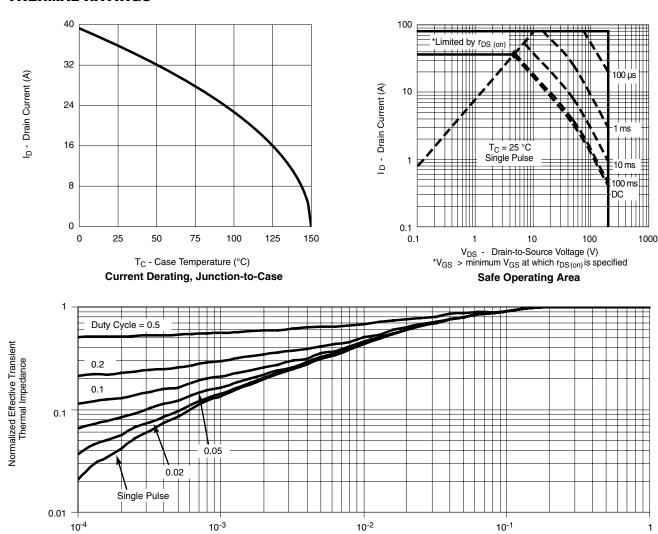




Single Pulse Avalanche Current Capability vs. Time



THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case

Square Wave Pulse Duration (sec)

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